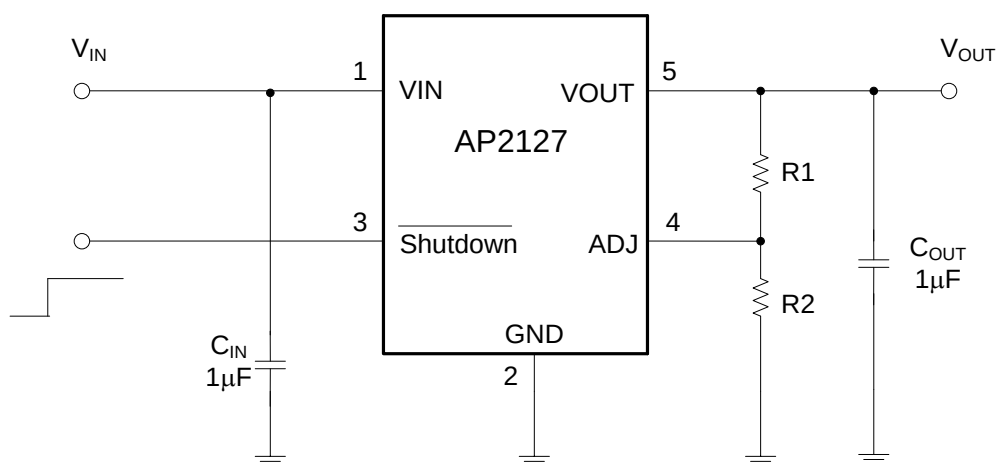
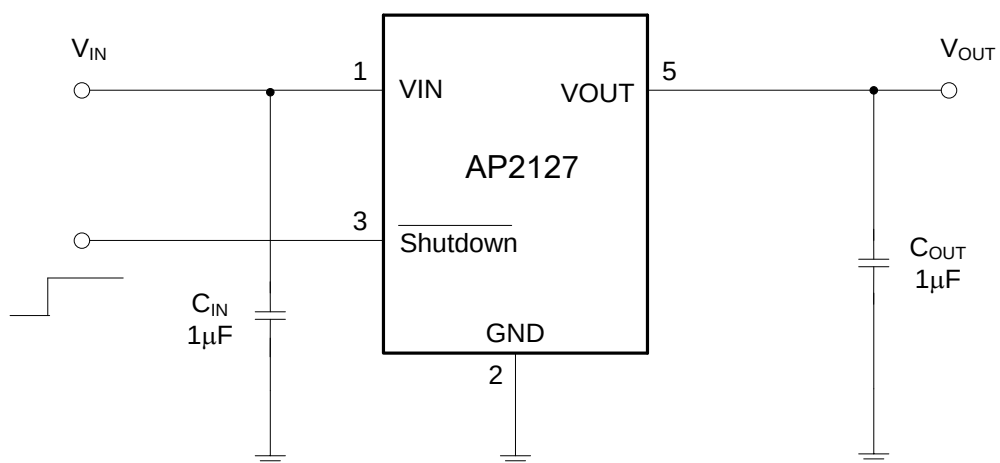


Typical Applications Circuit



$$V_{OUT} = 0.8(1 + R1/R2)V$$

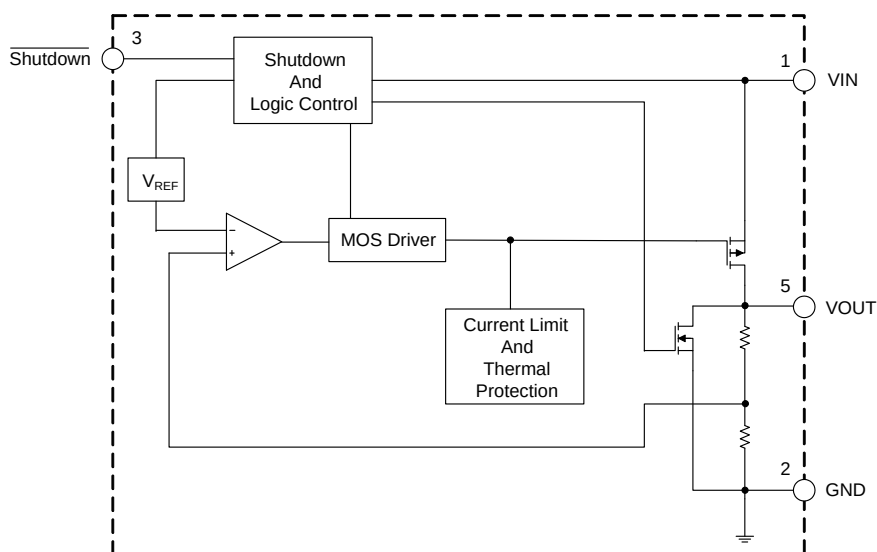


For Fixed Voltage Versions

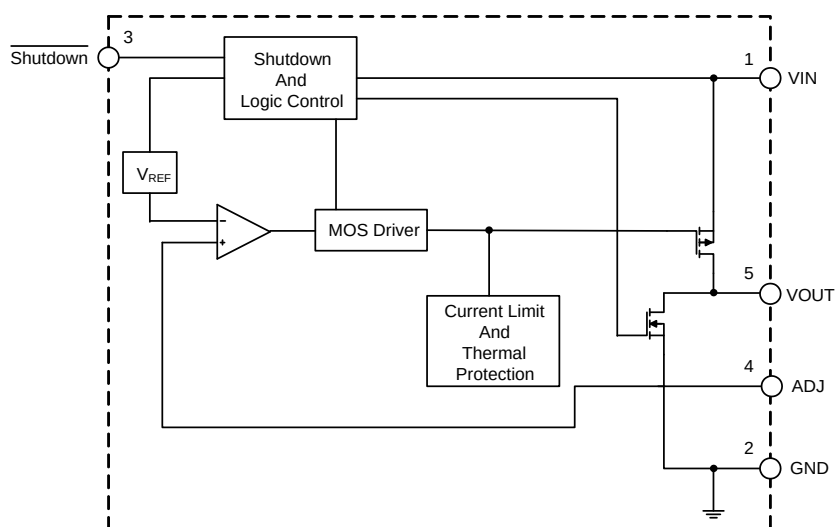
Pin Descriptions

Pin Name	Pin Number			Function
	SOT-23 SOT-23-3	SOT-23-5	SOT-89	
VIN	3	1	2	Power Input
VOUT	2	5	3	Power Output
GND	1	2	1	Ground
NC/ADJ	—	4	—	No Connection / VOUT feedback input, connect resistor divider.
Shutdown	—	3	—	Enable Input.
PAD	—	—	—	Exposed PAD for thermal performance improvement connect to GND

Functional Block Diagram



Fixed Version (SOT-23-5 Package)



Adjustable Version (SOT-23-5 Package)

Absolute Maximum Ratings (Note 4) (@T_A = +25°C, unless otherwise specified.)

Symbol	Parameter	Value		Unit
V _{IN}	Input Voltage	6.5		V
V _{CE}	Shutdown Input Voltage	-0.3 to V _{IN} +0.3		V
I _{OUT}	Output Current	450		mA
T _J	Junction Temperature	+150		°C
T _{STG}	Storage Temperature Range	-65 to +150		°C
T _{LEAD}	Lead Temperature (Soldering, 10sec)	+260		°C
θ _{JA}	Thermal Resistance (Junction to Ambient)	SOT-23	180	°C/W
		SOT-23-3	250	
		SOT-23-5	250	
		SOT-89	100	
ESD	ESD (Human Body Model)	6000		V
ESD	ESD (Machine Model)	200		V

Note: 4. Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "Recommended Operating Conditions" is not implied. Exposure to "Absolute Maximum Ratings" for extended periods may affect device reliability.

Recommended Operating Conditions (@T_A = +25°C, unless otherwise specified.)

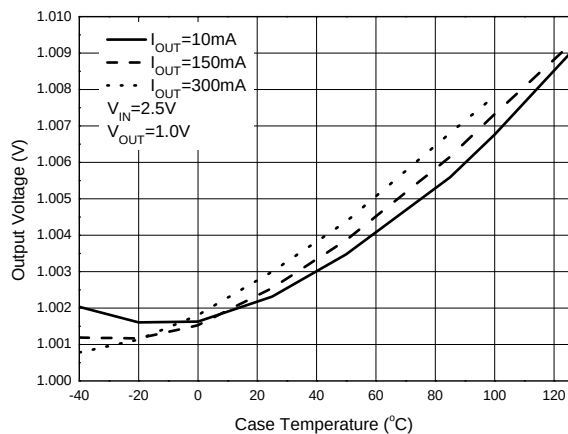
Symbol	Parameter	Min	Max	Unit
V _{IN}	Input Voltage	2.5	6	V
T _A	Operating Ambient Temperature Range	-40	+85	°C

Electrical Characteristics ($V_{IN} = 2.5V$ (for 0.8V to 1.8V voltage versions), $V_{IN} = V_{OUT} + 1V$ (for 2.5V to 4.75V voltage versions), $V_{IN} = 6V$ @ $V_{OUT} = 4.75V$, $T_A = +25^\circ C$, $C_{IN} = 1\mu F$, $C_{OUT} = 1\mu F$, **Bold** typeface applies over $-40^\circ C \leq T_A \leq +85^\circ C$, unless otherwise specified.)

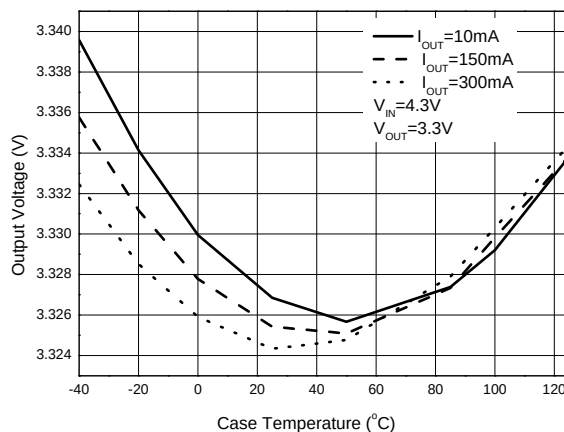
Symbol	Parameter	Conditions		Min	Typ	Max	Unit
V _{REF}	Reference Voltage	V _{IN} = V _{OUT} +1V 1mA ≤ I _{OUT} ≤ 300mA		0.784	0.8	0.816	V
V _{OUT}	Output Voltage	V _{IN} = V _{OUT} +1V 1mA ≤ I _{OUT} ≤ 300mA		98% x V _{OUT}	—	102% x V _{OUT}	V
V _{IN}	Input Voltage	—		2.5	—	6	V
I _{OUT(MAX)}	Maximum Output Current	V _{IN} - V _{OUT} = 1V V _{OUT} = 0.98 x V _{OUT}		300	400	—	mA
ΔV _{OUT}	Load Regulation	V _{IN} - V _{OUT} = 1V 1mA ≤ I _{OUT} ≤ 300mA		—	4	10	mV
ΔV _{OUT}	Line Regulation	V _{OUT} + 0.5V ≤ V _{IN} ≤ 6V I _{OUT} = 30mA		—	0.5	5	mV
V _{DROP}	Dropout Voltage	V _{OUT} = 1.0V, I _{OUT} = 300mA	—	1400	1500	mV	
		V _{OUT} = 1.2V, I _{OUT} = 300mA	—	1200	1300		
		V _{OUT} = 1.5V, I _{OUT} = 300mA	—	900	1000		
		V _{OUT} = 1.8V, I _{OUT} = 300mA	—	600	700		
		V _{OUT} = 2.5V, 2.8V, 3.0V, 3.3V, 4.2V, I _{OUT} = 300mA	—	170	300		
		V _{OUT} = 4.75V, I _{OUT} = 300mA	—	140	300		
I _Q	Quiescent Current	V _{IN} = V _{OUT} +1V, I _{OUT} = 0mA		—	60	90	μA
I _{STD}	Standby Current	V _{IN} = V _{OUT} +1V V _{SHUTDOWN} in off mode		—	0.1	1.0	μA
PSRR	Power Supply Rejection Ration	AP2127-1.0V to 4.2V, Ripple 1V _{P-P} V _{IN} = V _{OUT} +1V	f = 100Hz	—	68	—	dB
			f = 1kHz	—	68	—	dB
			f = 10kHz	—	54	—	dB
		AP2127-4.75V, Ripple 0.5V _{P-P} V _{IN} = V _{OUT} +1V	f = 100Hz	—	63	—	dB
			f = 1kHz	—	63	—	dB
			f = 10kHz	—	45	—	dB
ΔV _{OUT} /V _{OUT} /ΔT	Output Voltage Temperature Coefficient	I _{OUT} = 30mA, -40°C ≤ T _A ≤ +85°C		—	±100	—	ppm/°C
I _{SHORT}	Short Current Limit	V _{OUT} = 0V		—	50	—	mA
t _{SS}	Soft Start Time	—		—	50	—	μs
V _{NOISE}	RMS Output Noise	T _A = +25°C, 10Hz ≤ f ≤ 100kHz, V _{OUT} = 0.8V		—	60	—	μV _{RMS}
—	Shutdown High Voltage	Shutdown Input Voltage High		1.5	—	—	V
—	Shutdown Low Voltage	Shutdown Input Voltage Low		—	—	0.5	V
—	V _{OUT} Discharge MOSFET R _{DS(ON)}	Shutdown Input Voltage Low		—	60	—	Ω
—	Shutdown Pull Down Resistance	—		—	3	—	MΩ
—	Thermal Shutdown	—		—	+165	—	°C
—	Thermal Shutdown Hysteresis	—		—	+30	—	
θ _{JC}	Thermal Resistance	SOT-23		—	100	—	°C/W
		SOT-23-3		—	150	—	
		SOT-23-5		—	150	—	
		SOT-89		—	75	—	

Performance Characteristics (Note 5)

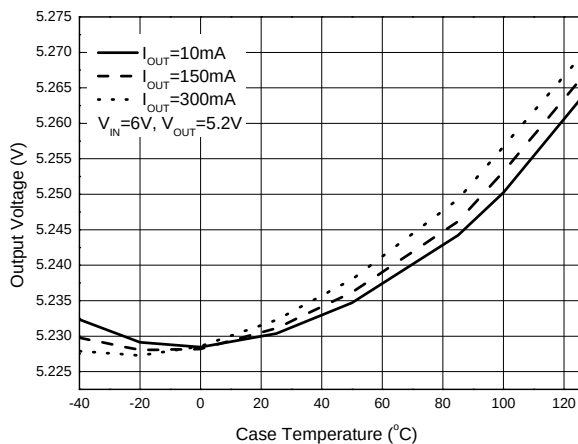
Output Voltage vs. Case Temperature



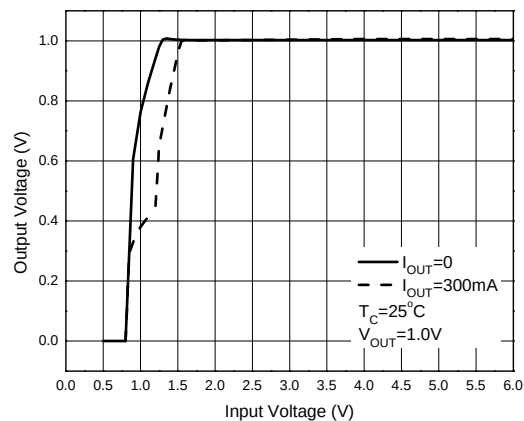
Output Voltage vs. Case Temperature



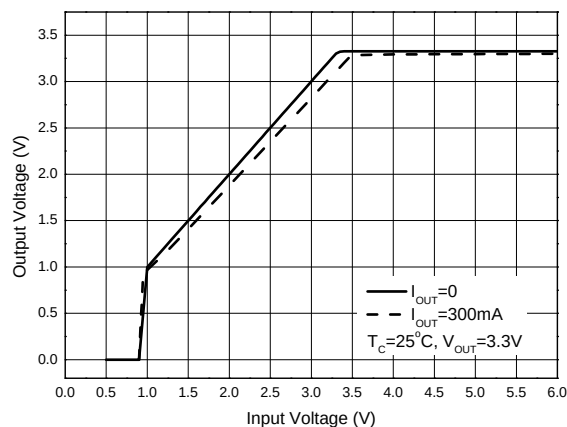
Output Voltage vs. Case Temperature



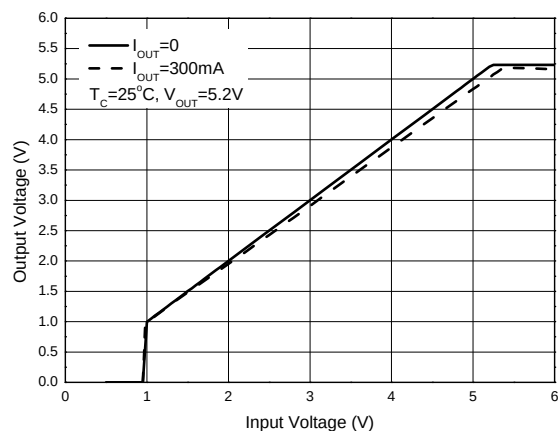
Output Voltage vs. Input Voltage



Output Voltage vs. Input Voltage



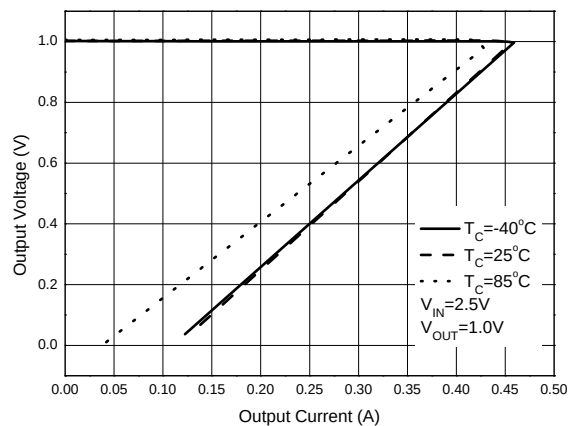
Output Voltage vs. Input Voltage



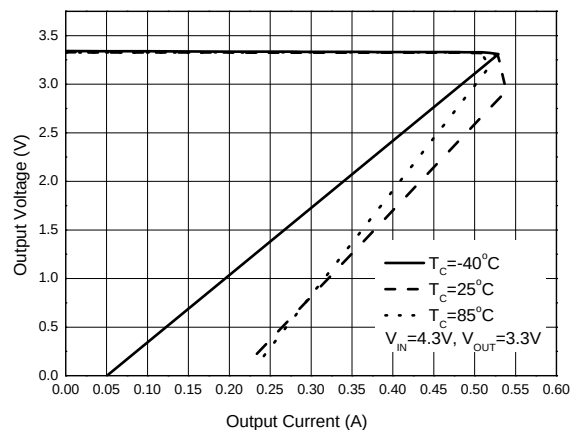
Note 5: Maximum output of 4.75V passed qualification test. Performance Characteristics for 5.2V are for reference only.

Performance Characteristics (Cont.) (Note 5)

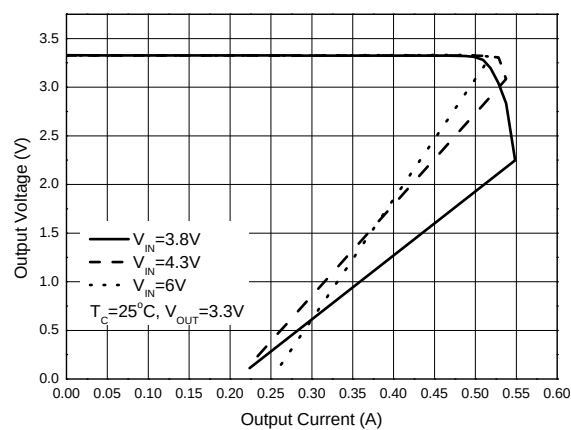
Output Voltage vs. Output Current



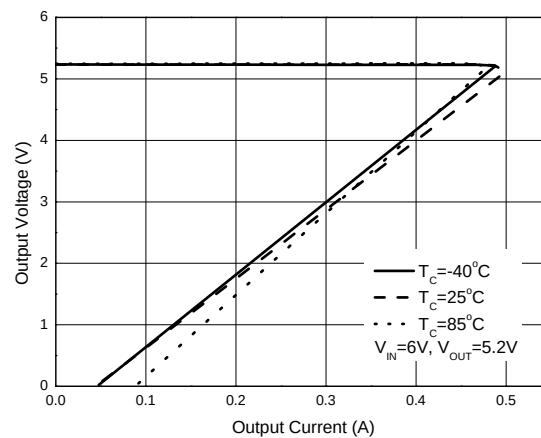
Output Voltage vs. Output Current



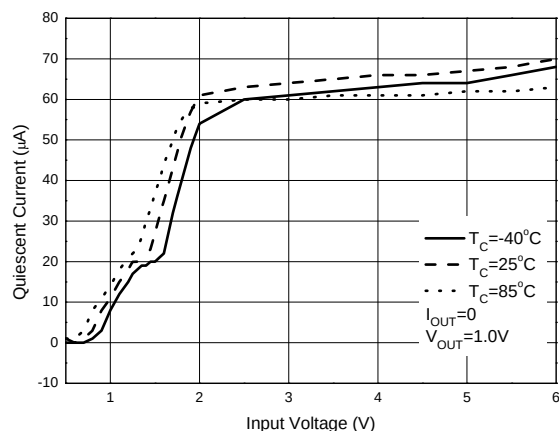
Output Voltage vs. Output Current



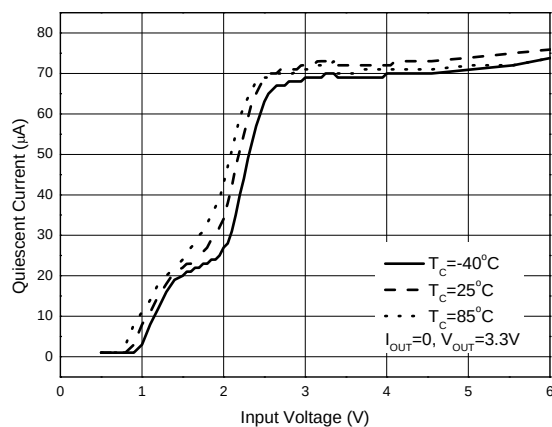
Output Voltage vs. Output Current



Quiescent Current vs. Input Voltage



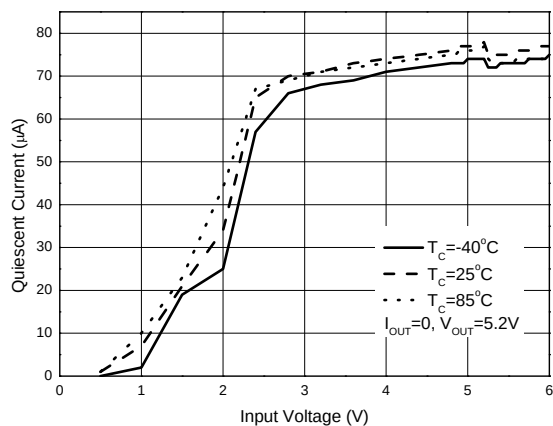
Quiescent Current vs. Input Voltage



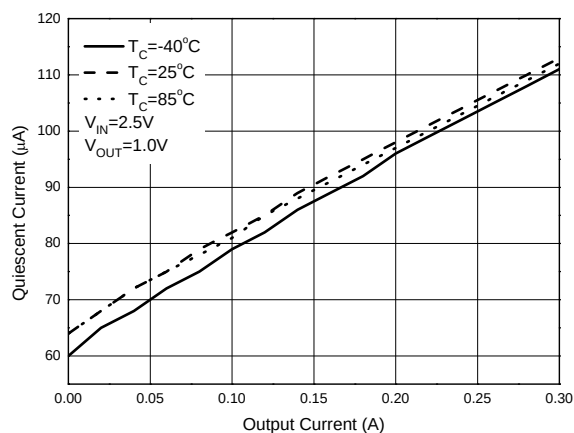
Note 5: Maximum output of 4.75V passed qualification test. Performance Characteristics for 5.2V are for reference only.

Performance Characteristics (Cont.) (Note 5)

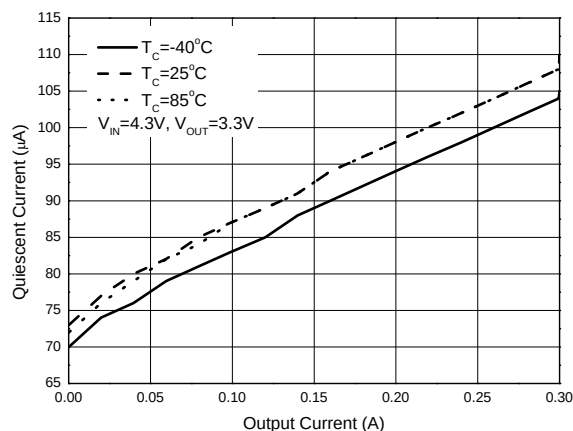
Quiescent Current vs. Input Voltage



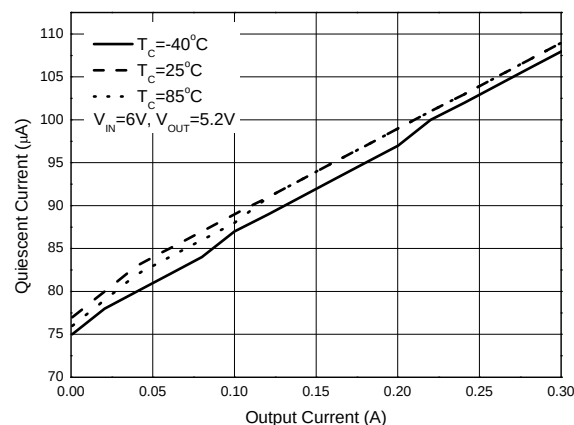
Quiescent Current vs. Output Current



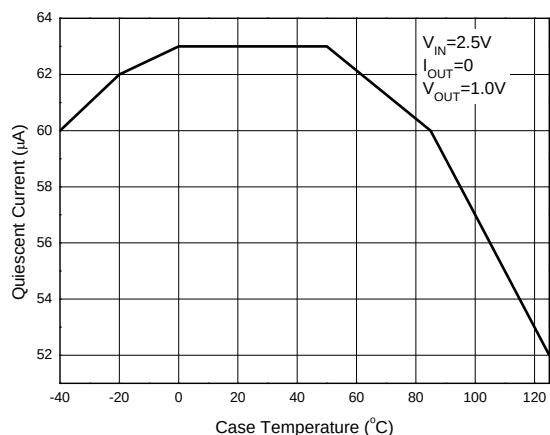
Quiescent Current vs. Output Current



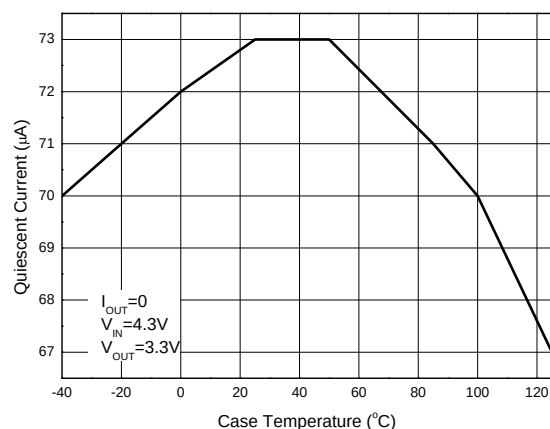
Quiescent Current vs. Output Current



Quiescent Current vs. Case Temperature



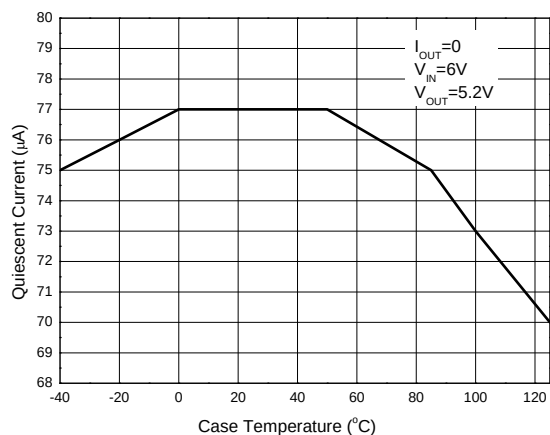
Quiescent Current vs. Case Temperature



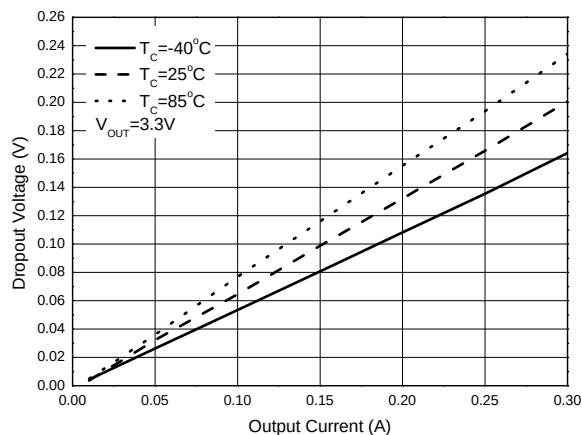
Note 5: Maximum output of 4.75V passed qualification test. Performance Characteristics for 5.2V are for reference only.

Performance Characteristics (Cont.) (Note 5)

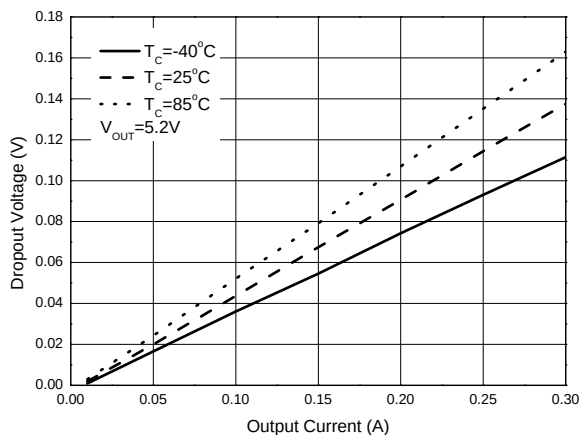
Quiescent Current vs. Case Temperature



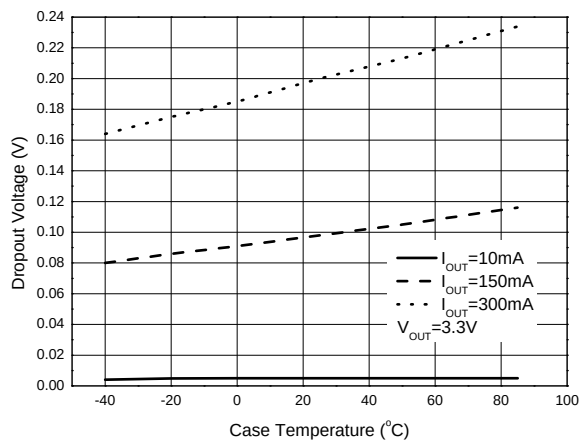
Dropout Voltage vs. Output Current



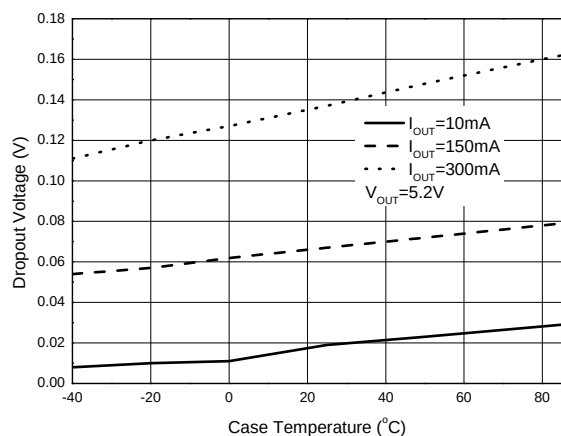
Dropout Voltage vs. Output Current



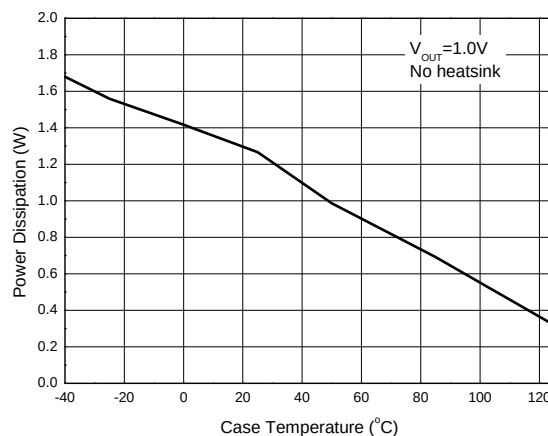
Dropout Voltage vs. Case Temperature



Dropout Voltage vs. Case Temperature



Power Dissipation vs. Case Temperature

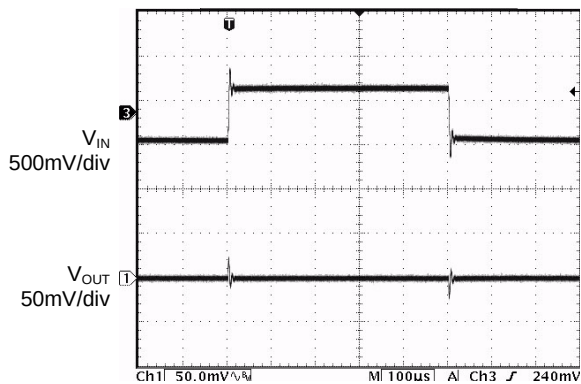


Note 5: Maximum output of 4.75V passed qualification test. Performance Characteristics for 5.2V are for reference only.

Performance Characteristics (Cont.) (Note 5)

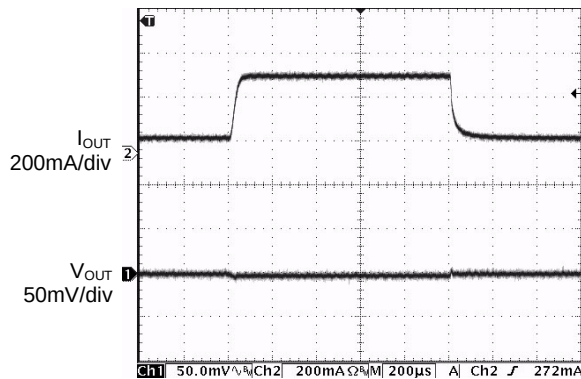
Line Transient

(Condition: $C_{IN}=C_{OUT}=1\mu F$, $I_{OUT}=10mA$,
 $V_{IN}=2.5V$ to $3.3V$, $V_{OUT}=1V$)



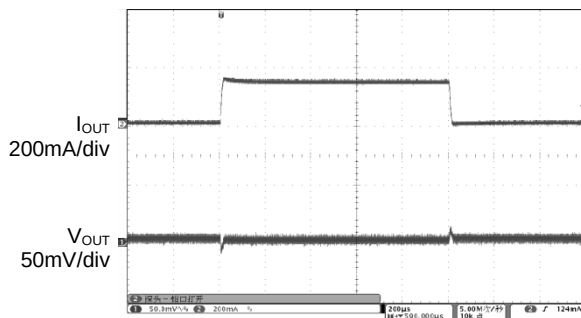
Load Transient

(Condition: $C_{IN}=C_{OUT}=1\mu F$, Slew Rate= $20mA/\mu s$,
 $V_{IN}=2.5V$, $V_{OUT}=1V$, $I_{OUT}=10mA$ to $300mA$)



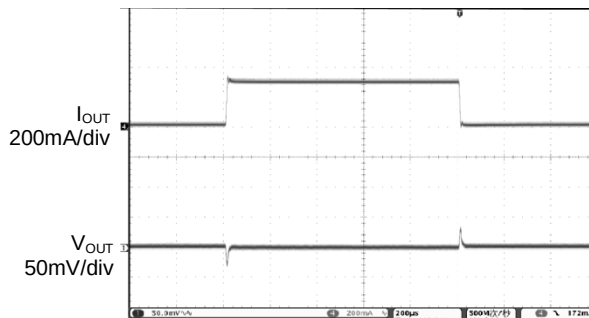
Load Transient

(Condition: $C_{IN}=C_{OUT}=1\mu F$, $I_{OUT}=10mA$ to $300mA$,
 $V_{IN}=4.3V$, $V_{OUT}=3.3V$)



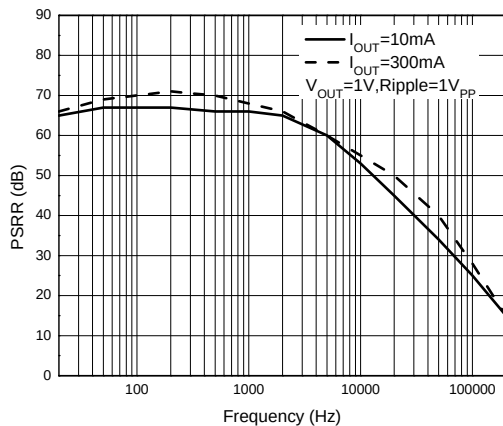
Load Transient

(Condition: $C_{IN}=C_{OUT}=1\mu F$, Slew Rate= $20mA/\mu s$,
 $V_{IN}=6V$, $V_{OUT}=5.2V$, $I_{OUT}=10mA$ to $300mA$)



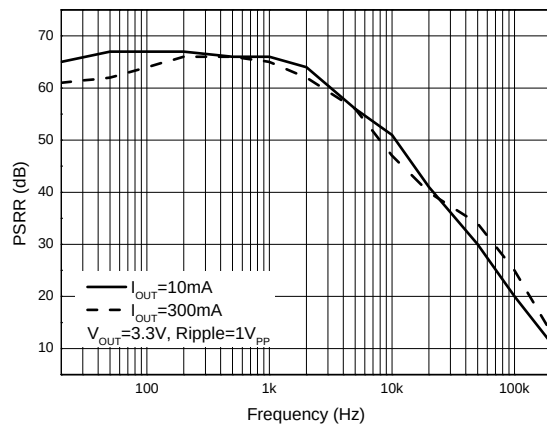
PSRR vs. Frequency

(Condition: $C_{IN}=C_{OUT}=1\mu F$, $V_{IN}=2.5V$, $V_{OUT}=1V$,
Ripple= $1V_{PP}$)



PSRR vs. Frequency

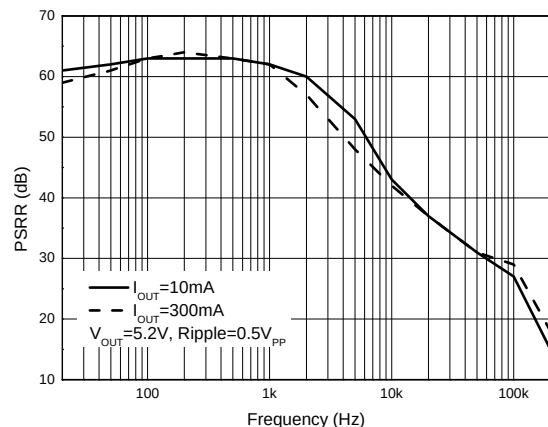
(Condition: $C_{IN}=C_{OUT}=1\mu F$, $V_{IN}=4.3V$, $V_{OUT}=3.3V$,
Ripple= $1V_{PP}$)



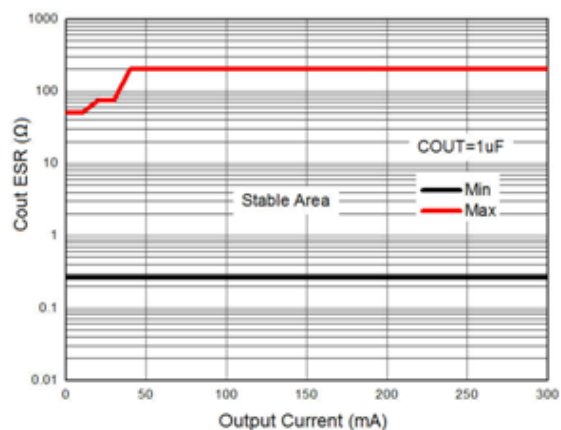
Note 5: Maximum output of 4.75V passed qualification test. Performance Characteristics for 5.2V are for reference only.

Performance Characteristics (Cont.) (Note 5)

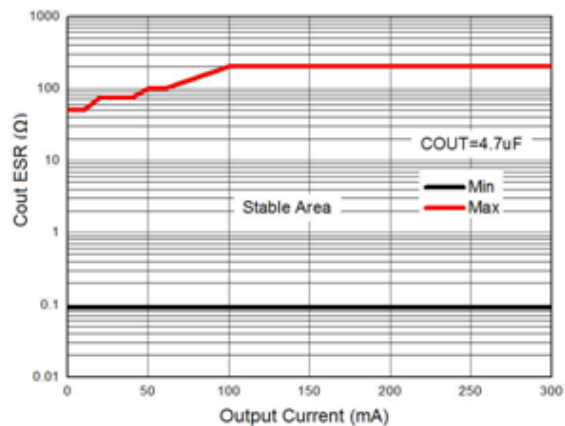
PSRR vs. Frequency
(Condition: $C_{IN}=C_{OUT}=1\mu F$, $V_{IN}=6V$, $V_{OUT}=5.2V$,
Ripple=0.5V_{PP})



Region of Stable C_{OUT} ESR vs. Output Current ($C_{OUT} = 1\mu F$)



Region of Stable C_{OUT} ESR vs. Output Current ($C_{OUT} = 4.7\mu F$)



Note 5: Maximum output of 4.75V passed qualification test. Performance Characteristics for 5.2V are for reference only.

Application Notes

Input Capacitor

A 1μF ceramic capacitor is recommended to connect between VIN and GND pins to decouple input power supply glitch and noise. The amount of the capacitance may be increased without limit. This input capacitor must be located as close as possible to the device to assure input stability and less noise. For PCB layout, a wide copper trace is required for both VIN and GND.

Output Capacitor

The output capacitor is required to stabilize and help transient response for LDO. The AP2127 is stable with very small ceramic output capacitor with a low ESR 1μF or higher of X7R or X5R MLCC capacitor, which will be sufficient at full temperature ranges. Additional capacitance helps to reduce undershoot and overshoot during transient. Place output capacitor as close as possible to VOUT and GND pins, and keep the leads as short as possible.

Adjustable Operation

For adjustable version, the output voltage is calculated by:

$$V_{OUT} = V_{REF} \left(1 + \frac{R_1}{R_2} \right)$$

Where $V_{REF} = 0.8V$ (the internal reference voltage)

Rearranging the equation will give the following that is used for adjusting the output to a particular voltage:

$$R_1 = R_2 \left(\frac{V_{OUT}}{V_{REF}} - 1 \right)$$

For AP2127, the resistor at the low side (R_2) can be selected from 5kΩ to 200kΩ.

In order to improve the stability and to decrease the noise level of the adjustable version, a feed-forward capacitor is suggested to be placed between VOUT and ADJ pins (Figure 1). It's recommended that this feed-forward capacitor value can be calculated as:

$$0.7kHz \leq \frac{1}{2\pi \times R_1 \times C_{ff}} \leq 15kHz$$

The recommended value of the feed-forward capacitor for different resistor divider ratios is shown in the table below.

Output Voltage	R1	R2	C _{ff}
1.2V	7.5kΩ	15kΩ	2.7nF
1.6V	7.5kΩ	7.5kΩ	2.7nF
1.8V	22.5kΩ	18kΩ	1nF
1.9V	7.5kΩ	5.49kΩ	2.7nF
2.5V	38.3kΩ	18kΩ	560pF
3.3V	56.2kΩ	18kΩ	390pF
4.0V	120kΩ	30.1kΩ	180pF

Table 1. Output Voltage Setting Guide

Application Notes (Cont.)

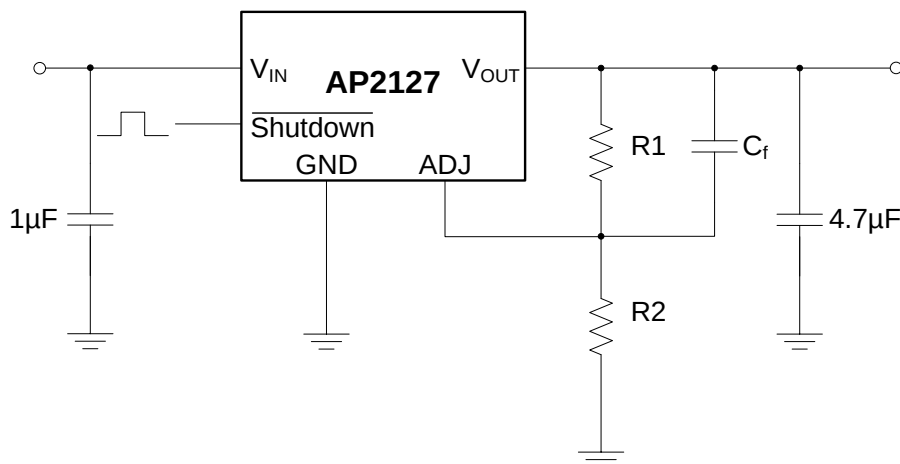


Figure 1. Application Circuit with Feed-forward Capacitor

Current Limit Protection

When output current at V_{OUT} pin is higher than current limit threshold, the current limit protection will be triggered and clamp the output current to prevent over-current and to protect the regulator and load from damaged due to overheating.

Short Circuit Protection

When V_{OUT} pin is shorted to GND, short circuit protection will be triggered and clamp the output current to approximately 50mA.

Auto discharge with Shutdown Version

For shutdown version, an auto discharge MOSFET with R_{DS(ON)} of 60Ω typical is integrated between V_{OUT} and GND pins, which can discharge the charge of the output capacitors quickly when turning off AP2127 with Shutdown pin.

Thermal Consideration

Internal thermal protection circuitry of AP2127 is used to protect device during overload conditions. For continuous operation, ensure not to exceed the operating junction temperature range of +125°C.

The power dissipation definition in the device is:

$$P_D = (V_{IN} - V_{OUT}) \times I_{OUT} + V_{IN} \times I_Q$$

The maximum power dissipation depends on the thermal resistance of IC package, PCB layout and the surrounding airflow. The maximum power dissipation can also be calculated as:

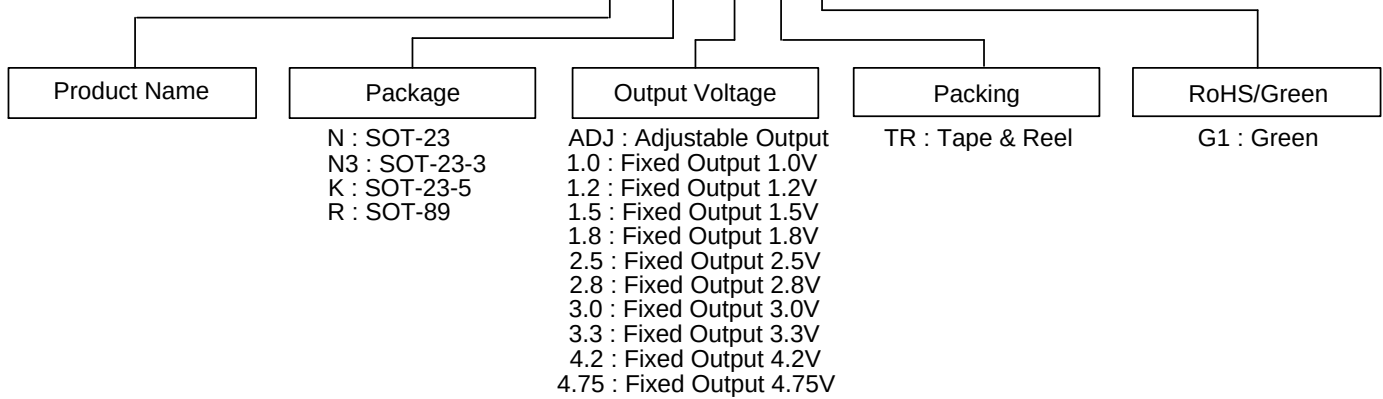
$$P_{D(MAX)} = (T_{J(MAX)} - T_A) / \theta_{JA}$$

The maximum power dissipation for SOT-23-5 package (least copper size) at T_A = +25°C can be calculated as:

$$P_{D(MAX)} = (125^\circ\text{C} - 25^\circ\text{C}) / (250^\circ\text{C/W}) = 0.4\text{W}$$

Ordering Information

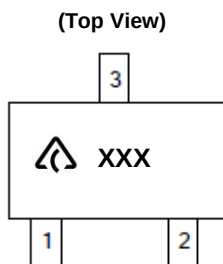
AP2127 XX - XXX XX XX



Part Number	Marking ID	Temperature Range	Package	Packaging
AP2127N-1.0TRG1	GU8	-40°C to +85°C	SOT-23	3000/Tape & Reel
AP2127N-1.2TRG1	GS8			3000/Tape & Reel
AP2127N-1.5TRG1	GV8			3000/Tape & Reel
AP2127N-1.8TRG1	GW8			3000/Tape & Reel
AP2127N-2.5TRG1	GT9			3000/Tape & Reel
AP2127N-2.8TRG1	GU9			3000/Tape & Reel
AP2127N-3.0TRG1	GV9			3000/Tape & Reel
AP2127N-3.3TRG1	GW9			3000/Tape & Reel
AP2127N3-1.2TRG1	GU2		SOT-23-3	3000/Tape & Reel
AP2127N3-1.5TRG1	GU3			3000/Tape & Reel
AP2127K-ADJTRG1	GEH		SOT-23-5	3000/Tape & Reel
AP2127K-1.0TRG1	GEG			3000/Tape & Reel
AP2127K-1.2TRG1	GEI			3000/Tape & Reel
AP2127K-1.5TRG1	GEP			3000/Tape & Reel
AP2127K-1.8TRG1	GEQ			3000/Tape & Reel
AP2127K-2.5TRG1	GER			3000/Tape & Reel
AP2127K-2.8TRG1	GES			3000/Tape & Reel
AP2127K-3.0TRG1	GHF			3000/Tape & Reel
AP2127K-3.3TRG1	GET			3000/Tape & Reel
AP2127K-4.2TRG1	GEU			3000/Tape & Reel
AP2127K-4.75TRG1	GEZ			3000/Tape & Reel
AP2127R-3.3TRG1	G42P		SOT-89	1000/Tape & Reel

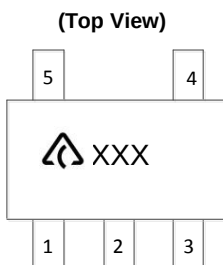
Marking Information

(1) SOT-23, SOT-23-3

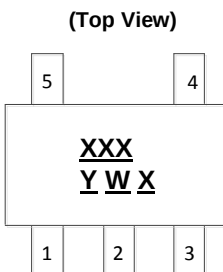


 : Logo
XXX : Marking ID (See Ordering Information)

(2) SOT-23-5

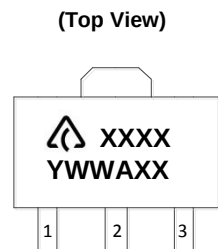


 : Logo
XXX : Marking ID (See Ordering Information)



XXX : Marking ID (See Ordering Information)
Y : Year 0 to 9
W : Week : A to Z : 1 to 26 week;
a to z : 27 to 52 week; z represents
52 and 53 week
X : Internal Code

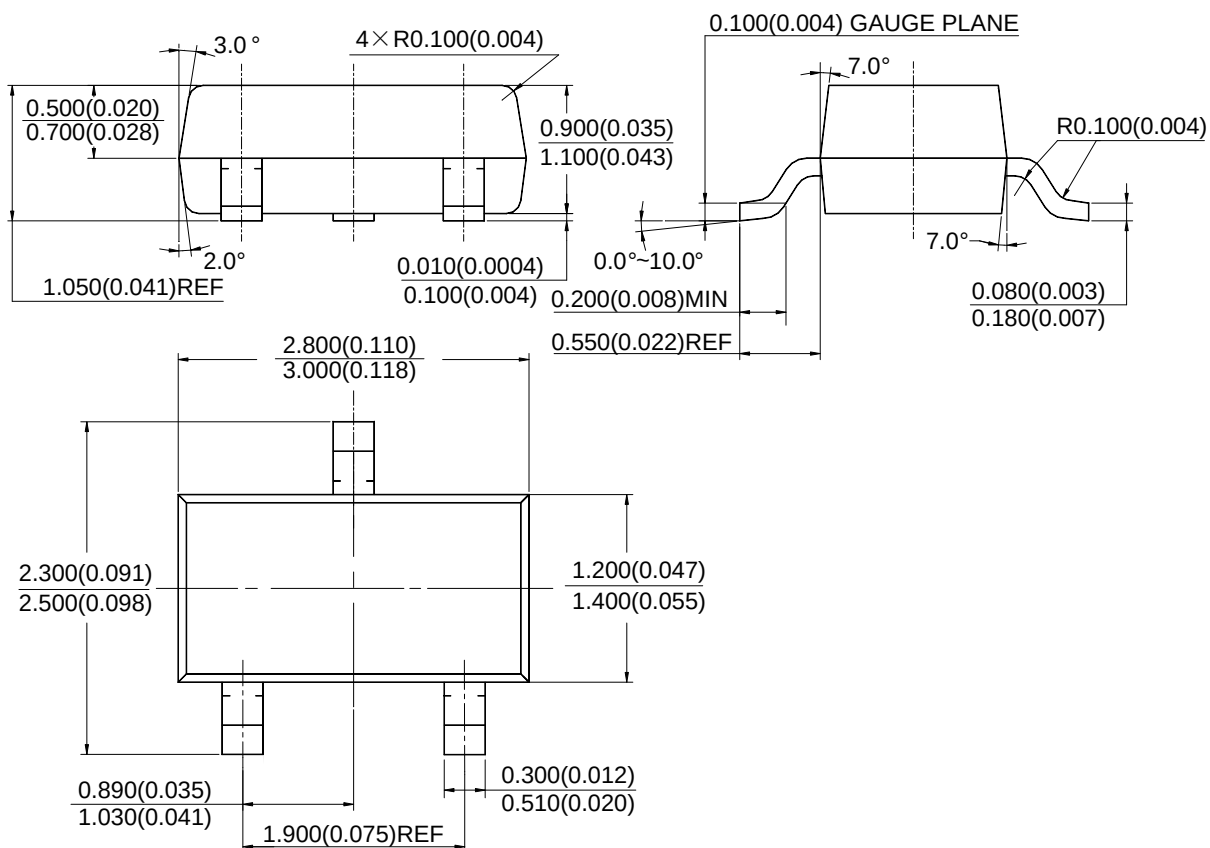
(3) SOT-89



First Line: Logo and Marking ID (See Ordering Information)
Second Line: Date Code
Y: Year
WW: Work Week of Molding
A: Assembly House Code
XX: 7th and 8th Digits of Batch Number

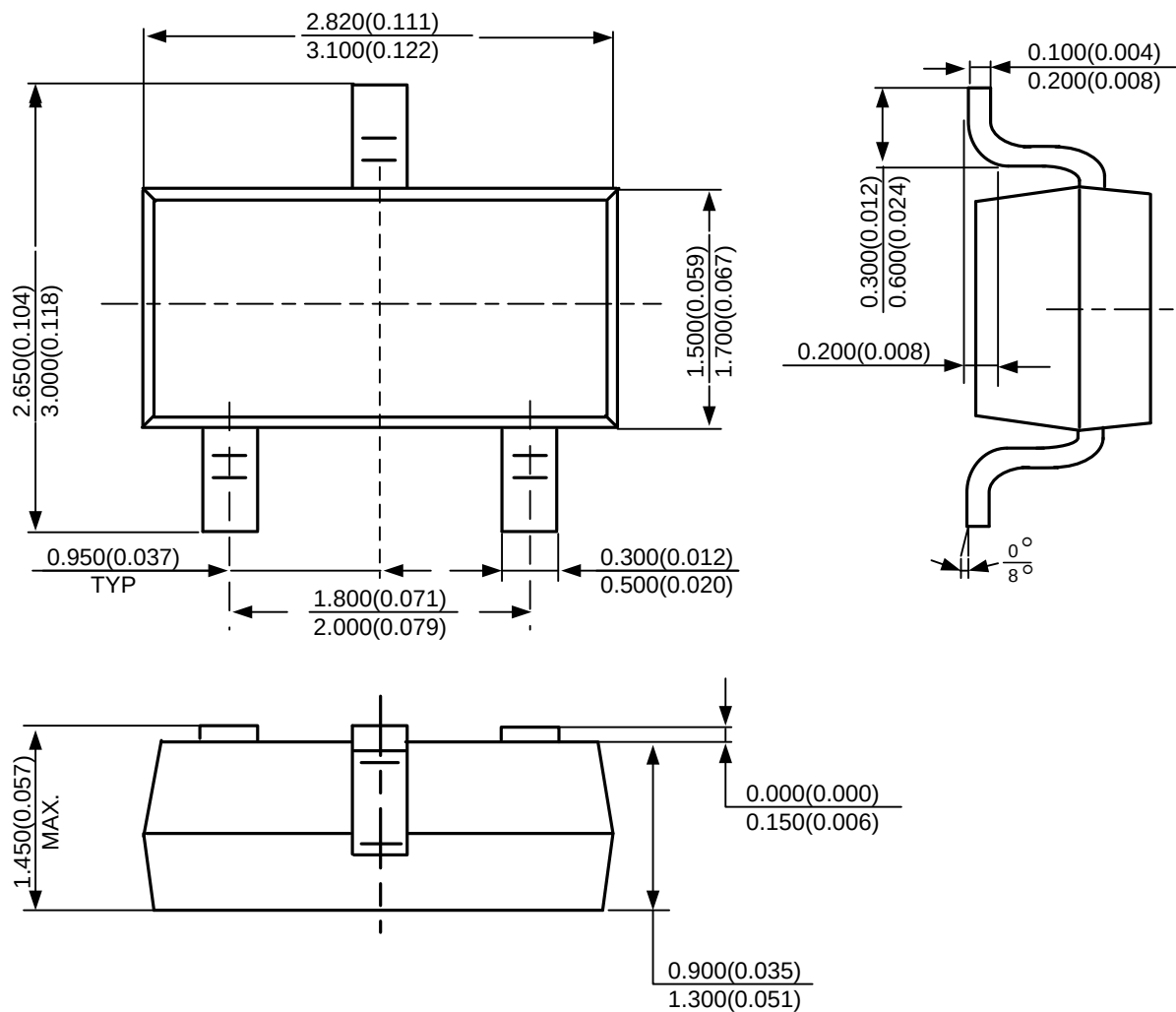
Package Outline Dimensions (All dimensions in mm.)

(1) Package Type: SOT-23



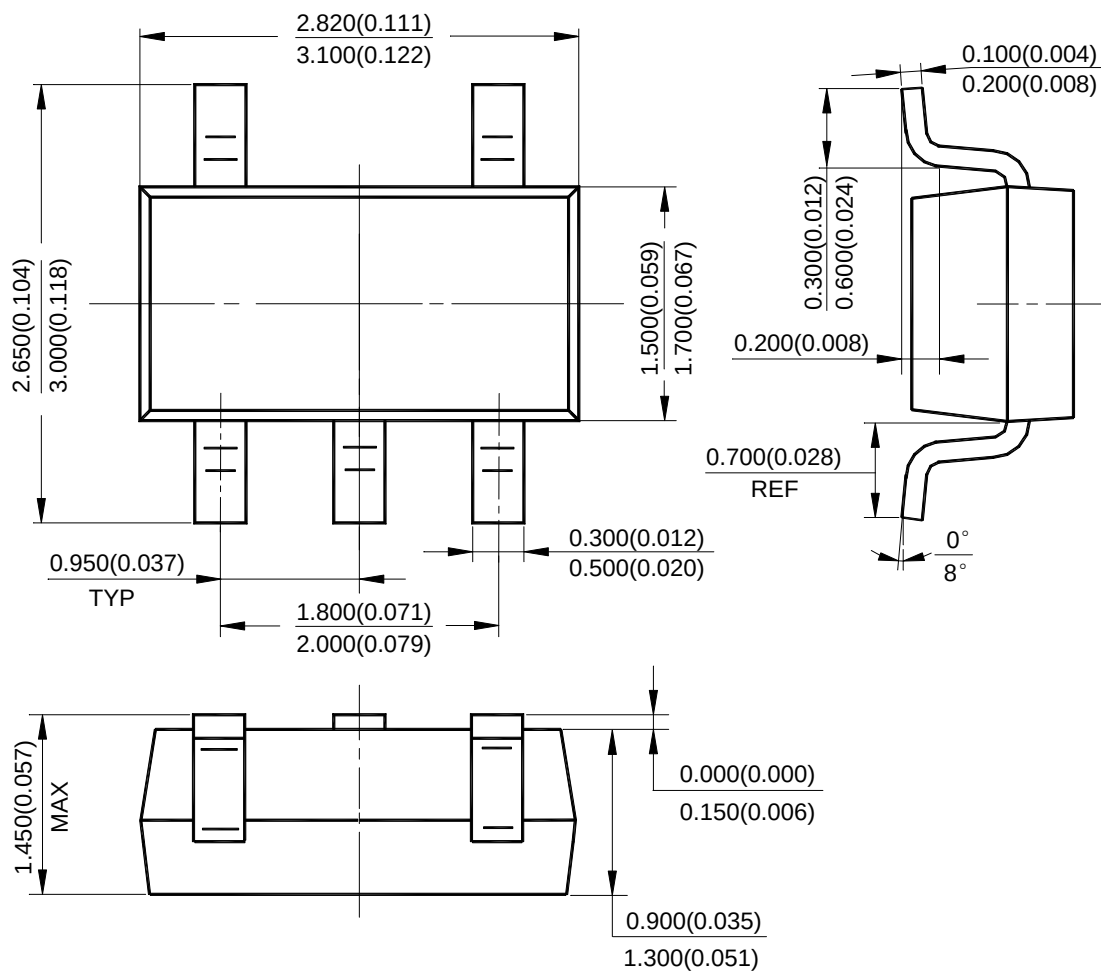
Package Outline Dimensions (Cont.) (All dimensions in mm.)

(2) Package Type: SOT-23-3



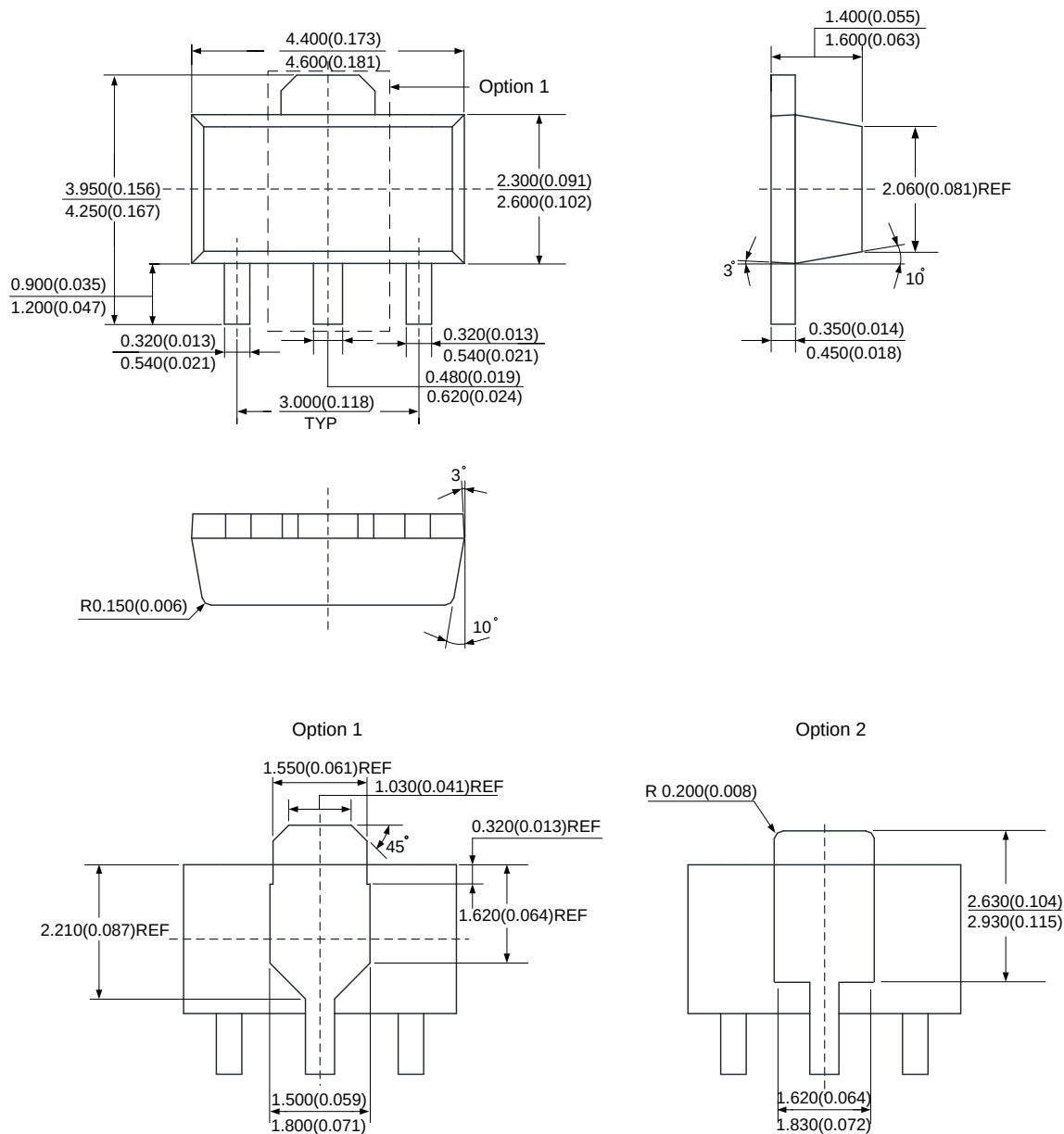
Package Outline Dimensions (Cont.) (All dimensions in mm.)

(3) Package Type: SOT-23-5



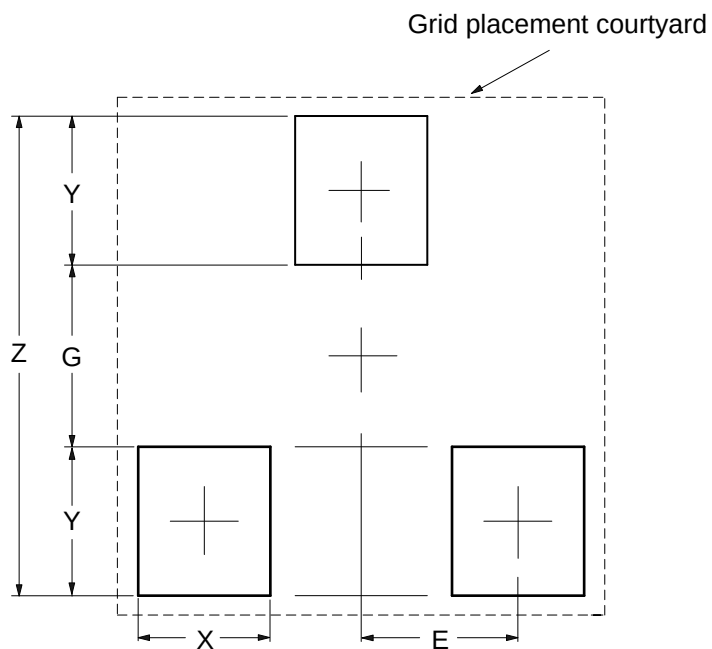
Package Outline Dimensions (Cont.) (All dimensions in mm.)

(4) Package Type: SOT-89



Suggested Pad Layout

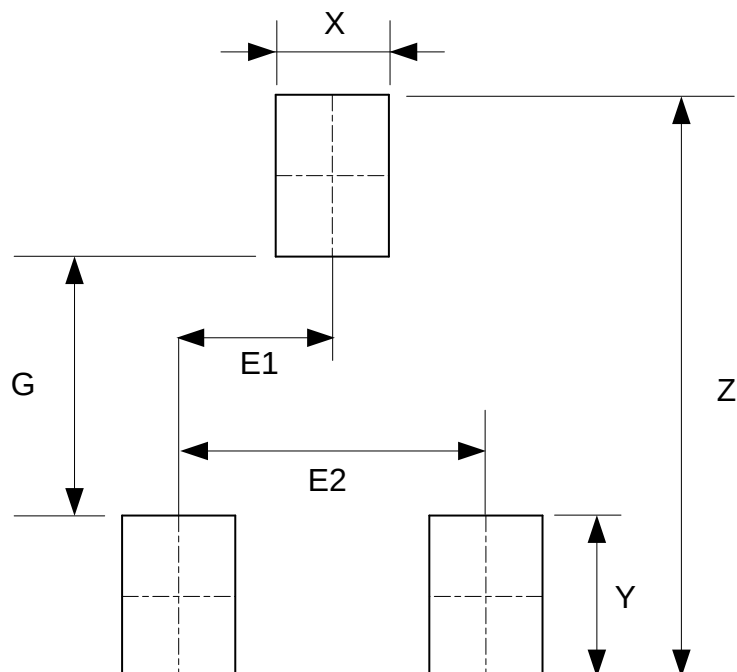
(1) Package Type: SOT-23



Dimensions	Z (mm)/(inch)	G (mm)/(inch)	X (mm)/(inch)	Y (mm)/(inch)	E (mm)/(inch)
Value	2.900/0.114	1.100/0.043	0.800/0.031	0.900/0.035	0.950/0.037

Suggested Pad Layout (Cont.)

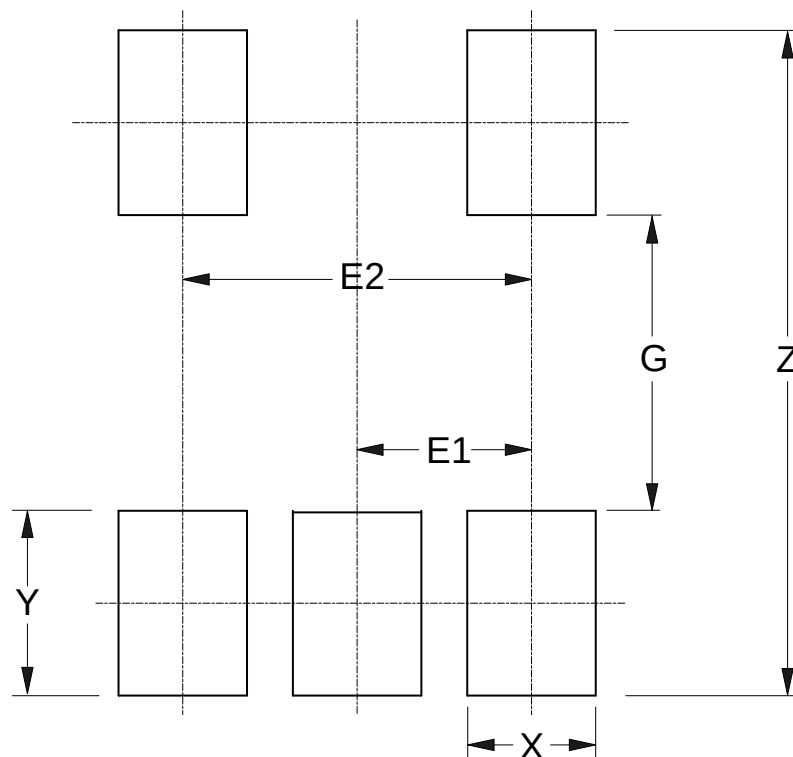
(2) Package Type: SOT-23-3



Dimensions	Z (mm)/(inch)	G (mm)/(inch)	X (mm)/(inch)	Y (mm)/(inch)	E1 (mm)/(inch)	E2 (mm)/(inch)
Value	3.600/0.142	1.600/0.063	0.700/0.028	1.000/0.039	0.950/0.037	1.900/0.075

Suggested Pad Layout (Cont.)

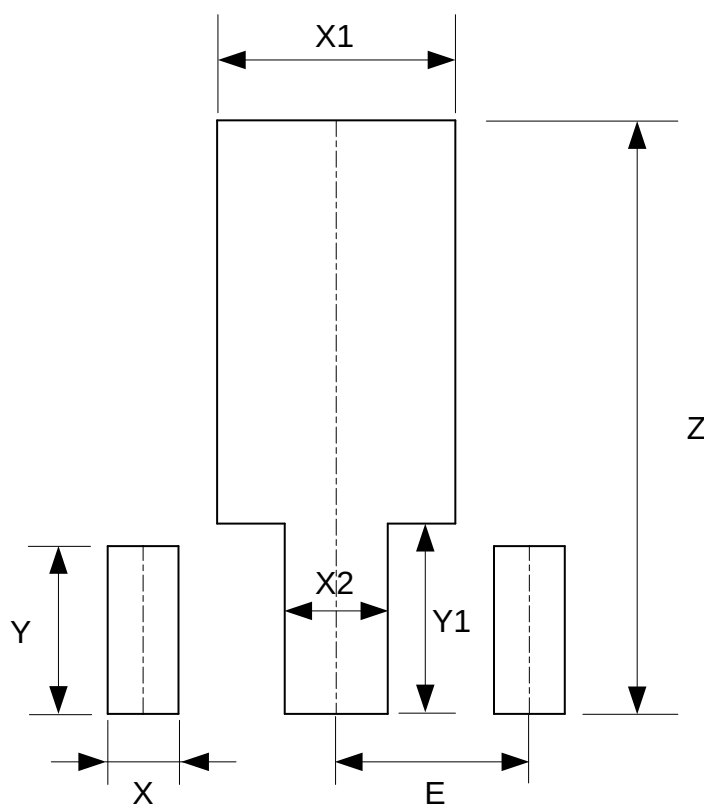
(3) Package Type: SOT-23-5



Dimensions	Z (mm)/(inch)	G (mm)/(inch)	X (mm)/(inch)	Y (mm)/(inch)	E1 (mm)/(inch)	E2 (mm)/(inch)
Value	3.600/0.142	1.600/0.063	0.700/0.028	1.000/0.039	0.950/0.037	1.900/0.075

Suggested Pad Layout (Cont.)

(4) Package Type: SOT-89



Dimensions	Z (mm)/(inch)	X (mm)/(inch)	X1 (mm)/(inch)	X2 (mm)/(inch)	Y (mm)/(inch)	Y1 (mm)/(inch)	E (mm)/(inch)
Value	4.600/0.181	0.550/0.022	1.850/0.073	0.800/0.031	1.300/0.051	1.475/0.058	1.500/0.059

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